

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT6434037

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEISEN BAI	08/30/2019
RECEIVING PARTY DATA	
Name:	DONGGUAN YUETAO PLASTIC ELECTRONICS TECHNOLOGY CO., LTD.
Street Address:	1-2F,B BUILDING, DONGHUI IND. PARK, SHITOUING IND. ZONE, WULIAN VILLAGE, FENGANG TOWN,
City:	DONGGUAN CITY
State/Country:	CHINA
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	29703880
Application Number:	29703879
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	WEISEN BAI
SIGNATURE:	/Weisen BAI/
DATE SIGNED:	12/06/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 1	
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ASSIGNMENT OF PATENT APPLICATION

Whereas I/we, Weisen BAI have invented certain improvements in:

Mobile phone protective case

and have executed two United States non-provisional design patent applications filed on 30th August 2019, which have been assigned Serial Nos 29703880 and 29703879 ;

And whereas Dongguan Yuetao Plastic Electronics Technology Co., Ltd., a corporation, having a place of business at 1-2F,B Building, Donghui Ind. park, Shitouling Ind. Zone, Wulian Village, Fenggang Town, Dongguan City, China, desires to acquire the entire right, title and interest in said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I the above named hereby sell, assign, and transfer to Dongguan Yuetao Plastic Electronics Technology Co., Ltd., its successors and assigns, the entire right, title and interest in said application and invention therein disclosed for the United States and foreign countries, and including, without limitation, any utility, continuation, divisional, and continuation-in-part applications, reissue, reexamination, extensions or foreign equivalents thereof, and all rights of priority and corresponding rights that are or may be secured under the laws of the United States and any foreign country, now or hereinafter in effect, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to Dongguan Yuetao Plastic Electronics Technology Co., Ltd., its successors and assigns; and I hereby agree that Dongguan Yuetao Plastic Electronics Technology Co., Ltd. may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Dongguan Yuetao Plastic Electronics Technology Co., Ltd..

Signed

Inventor's signature: /Weisen BAI/

Date: 30th August 2019

Name: Weisen BAI

Residence: 1-2F,B Building, Donghui Ind. park, Shitouling Ind. Zone, Wulian Village, Fenggang Town, Dongguan City, China